BORN SEMICONDUCTOR

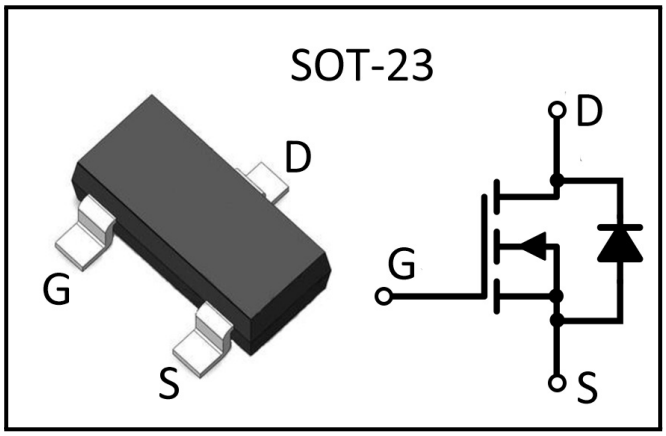
AO3400

N-Channel MOSFET

Features

- V_{DS}=30V
- I_D=5A
- $R_{DS(ON)}$ @V_{GS}=10V, TYP=25mΩ
- $R_{DS(ON)}$ @V_{GS}=4.5V, TYP=30mΩ

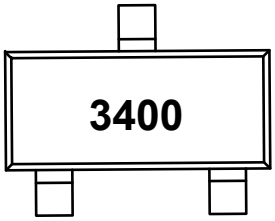
Package



Description

- Advanced trench process technology
- High Density Cell Design For Ultra LowOn-Resistance
- SOT-23 for Surface Mount Package.

Marking



Ordering information

Order code	Package	Marking	Base qty	Delivery mode
AO3400	SOT-23	3400	3K	Tape and reel

Absolute Maximum Ratings (@T_A=25°C unless otherwise noted)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-Source Voltage		30	V
V_{GS}	Gate-Source Voltage		±12	V
I_D	Continuous Drain Current		5	A
I_{DM}	Pulsed Drain Current		18	A
P_D	Maximum Power Dissipation	T_A = 25°C	1.4	W
T_J	Junction		150	°C
T_{stg}	Storage Temperature		-55 to + 150	°C

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AO3400

N-Channel MOSFET

Electrical Characteristics @T_A=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
Static						
BV_{DS}	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250uA	30	–	–	V
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250uA	0.6	1.0	1.4	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 30V, V_{GS} = 0V	–	–	1	uA
I_{GSS}	Gate Body Leakage	V_{GS} = ±12V, V_{DS} = 0V	–	–	±100	nA
$R_{DS(on)}$	Drain-Source On-State Resistance	V_{GS} = 10V, I_D = 5A	–	25.0	35.0	mΩ
		V_{GS} = 4.5V, I_D =4A	–	30.0	40.0	
		V_{GS} = 2.5V, I_D = 3A	–	40.0	55.0	
Dynamic						
C_{iss}	Input Capacitance	V_{DS} = 15V,f=1MHZ	–	545	–	pF
C_{oss}	Output Capacitance	V_{GS} = 0V,	–	66	–	
$t_{d(on)}$	Turn-On Delay Time	V_{DS} = 15V, R_{GEN} = 6Ω,	–	9.6	–	ns
$t_{d(off)}$	Turn-Off Delay Time	V_{GS} = 10V,	–	39	–	
Source-Drain Diode						
V_{SD}	Diode Forward Voltage	I_S = 1.25A,V_{GS} = 0V	–	0.7	1.0	V

Notes:(1)Pulse test pulse width <=300us,duty cycle <= 2%.

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AO3400

N-Channel MOSFET

Typical Performance Characteristics(T_J = 25 °C, unless otherwise noted)

Figure 1 :Output Characteristics

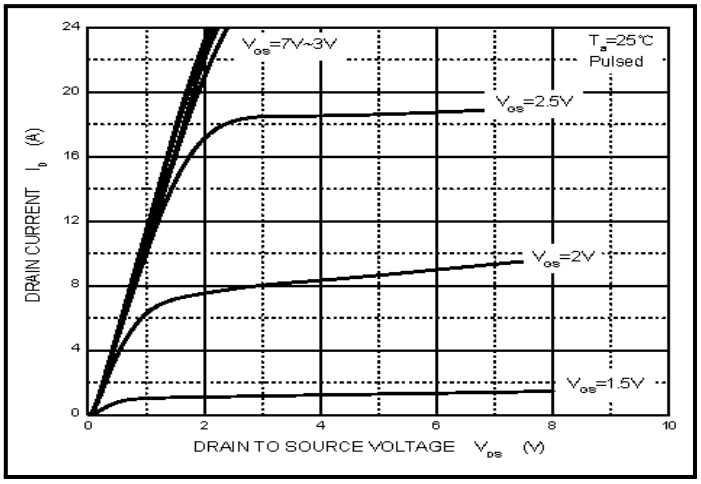


Figure 2 :Transfer Characteristics

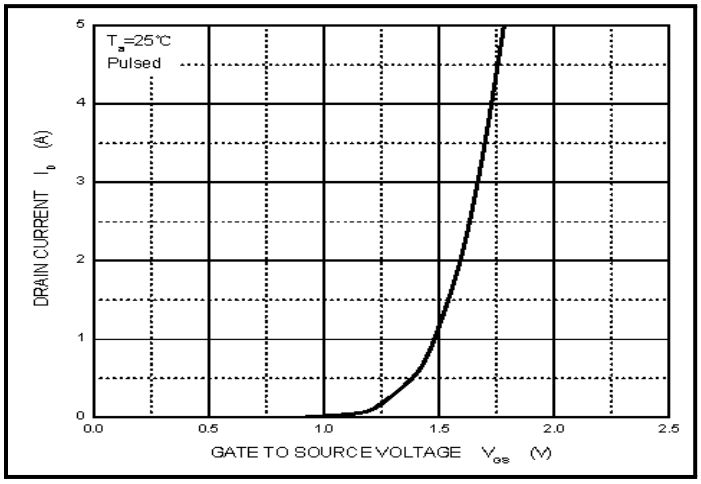


Figure 3 :On-Resistance vs. Drain Current

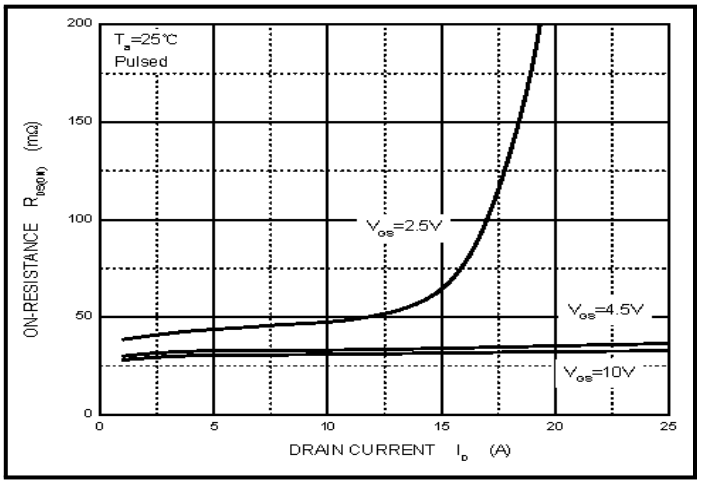


Figure 4 :$R_{DS(on)}$——V_{GS}

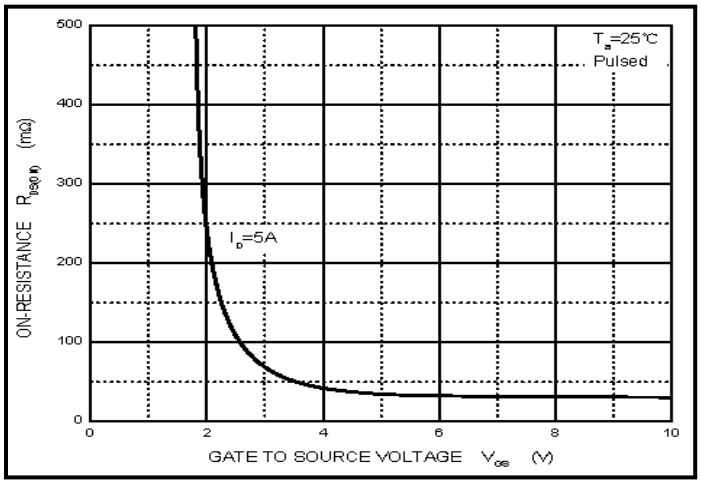
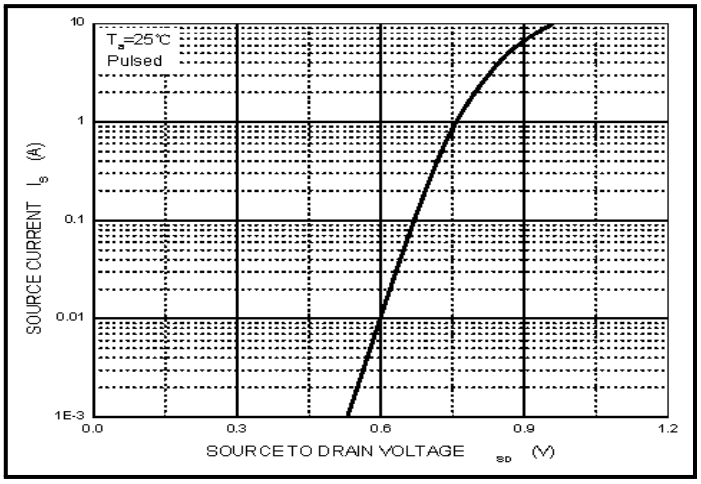


Figure 5 :I_S--V_{SD}

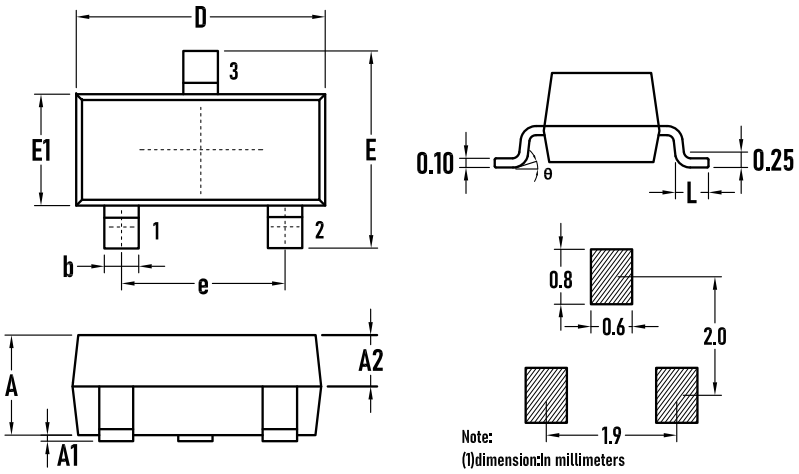


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AO3400

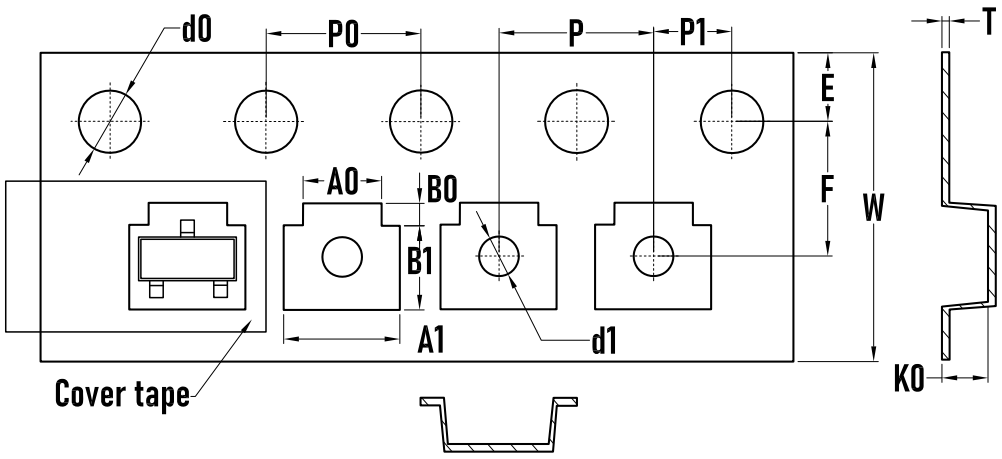
N-Channel MOSFET

Outline Drawing - SOT-23



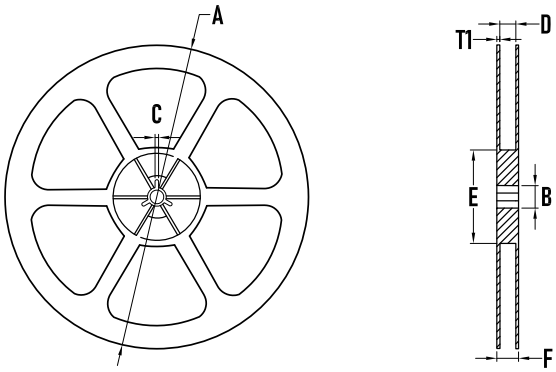
SYMBOL	MILLIMETER		
	MIN.	Typ.	MAX.
A	0.90	1.00	1.10
A1	0.01	–	0.10
A2	0.50	0.60	0.70
D	2.80	2.90	3.00
b	0.25	0.35	0.45
E	2.10	2.30	2.50
E1	1.20	1.30	1.40
e	1.80	1.90	2.00
L	0.25	0.35	0.45
θ	0	–	8°

Packaging Tape - SOT-23



SYMBOL	MILLIMETER
A0	2.10±0.10
A1	3.10±0.10
B0	0.65±0.10
B1	2.75±0.10
d0	1.55±0.10
d1	1.00±0.05
E	1.75±0.10
F	3.50±0.10
K0	1.10±0.10
P	4.00±0.10
P0	4.00±0.10
P1	2.00±0.10
W	8.00±0.30
T	0.20 ±0.05

Packaging Reel



SYMBOL	MILLIMETER
A	177.8±0.2
B	3.1
C	13.50
D	9.6±0.3
E	75±0.2
F	12.3±0.3
T1	1.0±0.2
Quantity	3000PCS

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